

Harvatek Surface Mount LED Data Sheet HT-U16DSWH

Official Product	Product: HT-U16DSWH	Data Sheet No.		
		HT-U16DSWH		
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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity (mcd)	Forward Voltage V _F (V)	Orderable Part Number
HT-U16DSWH	White	InGaN	150	11250 minimum	3.3 typ	HT-U16DSWH

	Specification	Material	Quantity
ESD	2000V (HBM)		
Resin	Water clear	Silicone	
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	
		·	

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well. All raw materials used in the construction of this device comply with UL 94V-0

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and

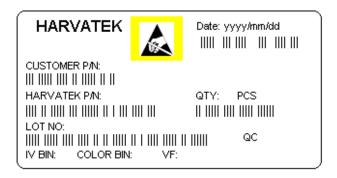
InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

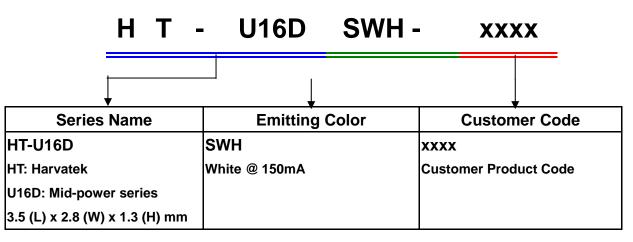
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Label Specifications



Harvatek P/N:



Lot No.:

1	2	3	4	5	6	7	8	9	10
Ρ	1	2	2	3	0	Α	-	D	Т

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Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
		1: Jan.				
	Z: 2000	2: Feb.				
Internal	1: 2001			D. Diffuse ed		
Tracing	2: 2002	9: Sep.	1~31/ (30)	1~31/ (30) A,B,C	D: Diffused	T: Tape & Reel
Code	3: 2003	A: Oct.			C: Clear	
		B: Nov.				
		C: Dec.				

Luminous Intensity Bin:

Rank Code	Symbol	Condition	Min.	Тур.	Max.	Unit
AK1			11250	-	12500	
AK2	lv	I _F =150mA	12500	-	14000	mcd
AL1			14000	-	15600	

@150mA / Ta=25⁰ C, Tolerance: <u>+</u> 10%

Luminous Flux Bin:

Rank Code	Symbol	Condition	Min.	Тур.	Max.	Unit
PP2	ΦV	L=150mA	26.8	-	30.6	Im
PQ1	Ψν	I _F =150mA	30.6	-	34.9	Im

@150mA / Ta=25[°] C, Tolerance: <u>+</u> 10% (Note : Luminous Flux Bin table for reference)

Forward Voltage (V_F) Bin:

Bin Code	Spec. Range
H6	3.0-3.2 V
J5	3.2-3.4 V
J6	3.4-3.6 V
K5	3.6-3.8 V

@150mA / Ta=25 $^{\circ}$ C, Tolerance: <u>+</u> 0.05 V

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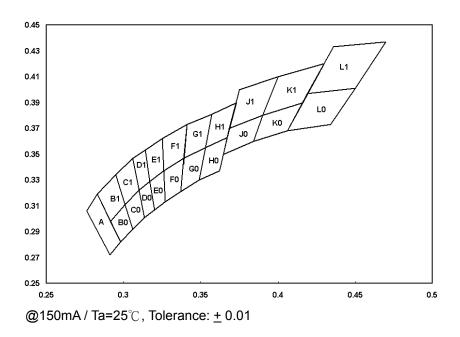


Correlated Color Temperature Rank for White

Color	Condition	Bin Code	Min.	Тур.	Max.
	I _F =150mA	K1	3,250	3,500	3,750
Warm White		KO	3,250	3,500	3,750
		J1	3,750	4,000	4,250
		JO	3,750	4,000	4,250

Tolerance: ±5%

Correlated Color Temperature and Chromaticity Correlation (for White)



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Product Characteristics

Absolute Maximum Ratings

Product	Emission Color	P _d (mW)	I⊧ (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (⁰C)	T _{S⊺} (ºC)
HT-U16DSWH	White	570	180	200	5	-40~+100	-40~+100

* Condition for $I_{\ensuremath{\text{FP}}\xspace}$ is pulse of 1/10 duty and 0.1msec width

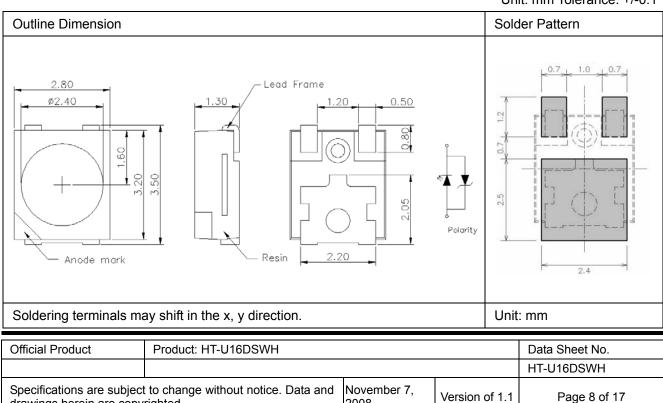
Electro-Optical Characteristics									
								($T_a = 25 \circ C$
			VF(V)		λ(nm)			lv (mcd)	
Product	Emission Color	l⊧(mA)	typ	max	λ_{D}	λ _P	Δλ	min	typ
HT-U16DSWH	White	150	3.3	3.9	X=0.38 Y=0.37		11250	14000	

* Per NIST standard

drawings herein are copyrighted.

Package Outline Dimension and Recommended Soldering Pattern

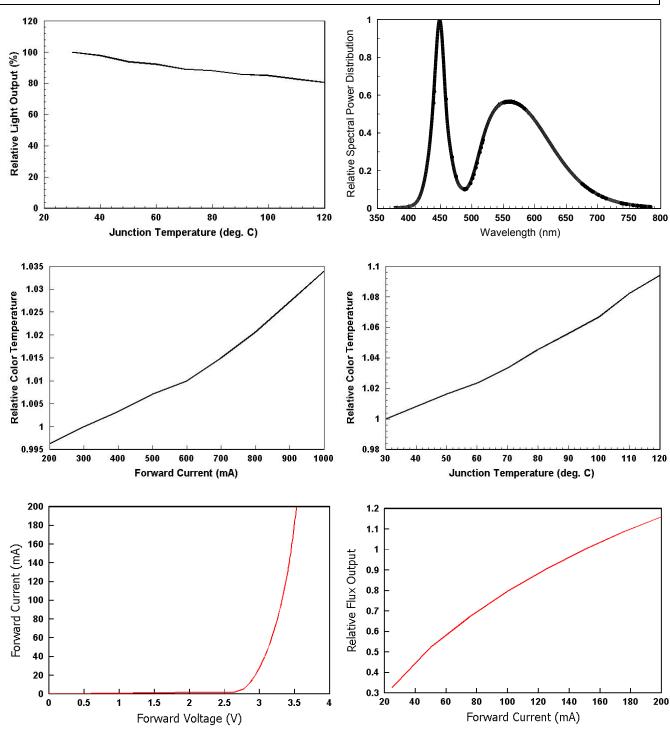
Unit: mm Tolerance: +/-0.1



2008

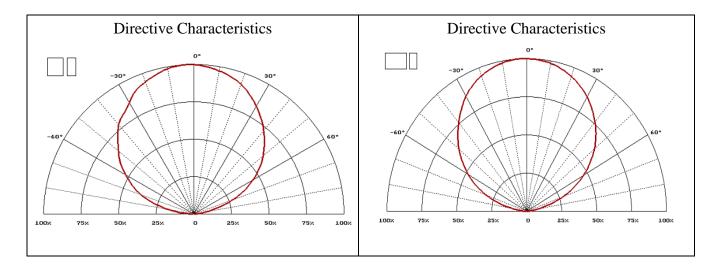
0.5W White SMD LED HT-U16DSWH

Characteristic Curves



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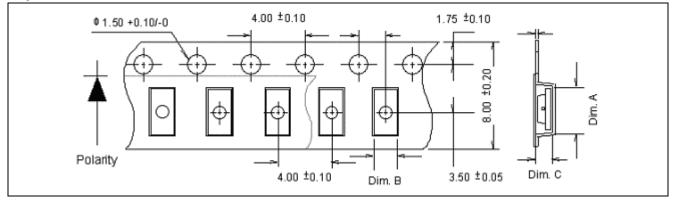
Radiation Pattern



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Packaging

Tape Dimension

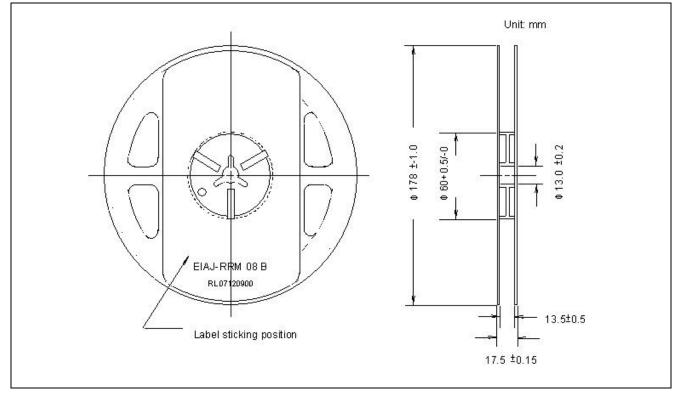


Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-U16D	3.7+/-0.1	3.0+/-0.1	1.5+/-0.1	2K

Unit: mm

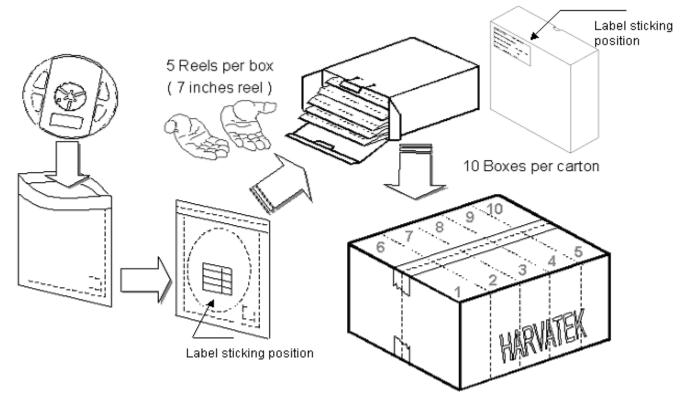
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Reel Dimension



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Packing



5 boxes per carton is available depending on shipment quantity.

	Specification	Material	Quantity		
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel		
Reel	Per EIA 481-1A specs	Conductive black			
Label	HT standard	Paper			
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag		
Carton	HT standard	Paper	Non-specified		
Others:					
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same					
bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of					
a product label as well.					

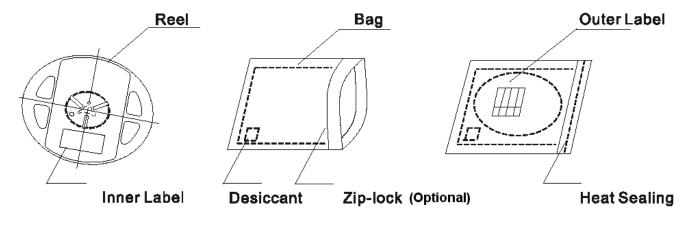
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:

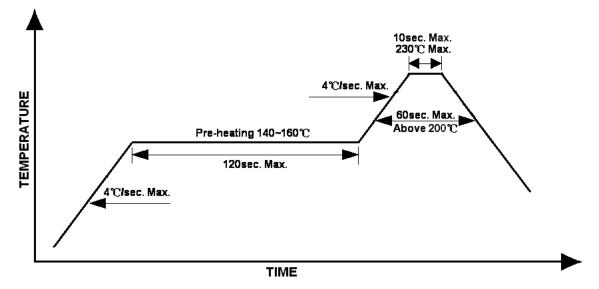


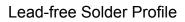
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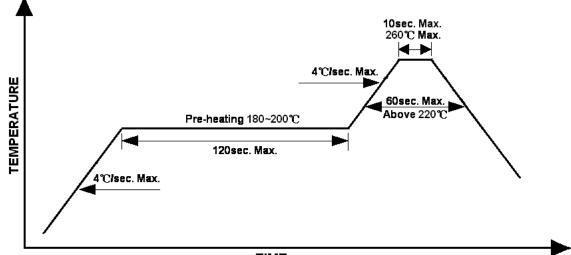
Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead Solder Profile







Т	IN	1E	

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Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^oC max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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Revision History

Changes since last revision	Page	Version No.	Revision Date
New Format		1.0	3/4/2008
Amend Brightness Range		1.1	11/7/2008

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